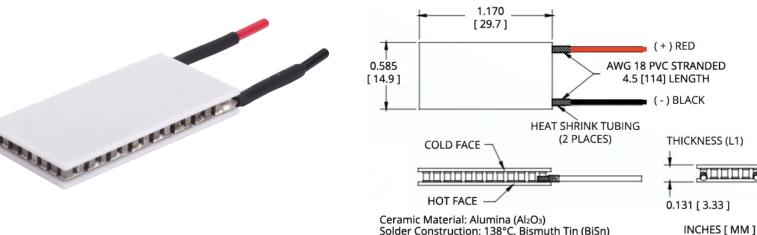
#### Ceramic Plate Series Thermoelectric Cooler

The CP14-35-045-L1-RT-W4.5 is a high-performance and highly reliable standard Thermoelectric Cooler. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics. It has a maximum Qc of 19.7 Watts when  $\Delta T = 0$  and a maximum  $\Delta T$  of 70.5 °C at Qc = 0.

#### **Features**

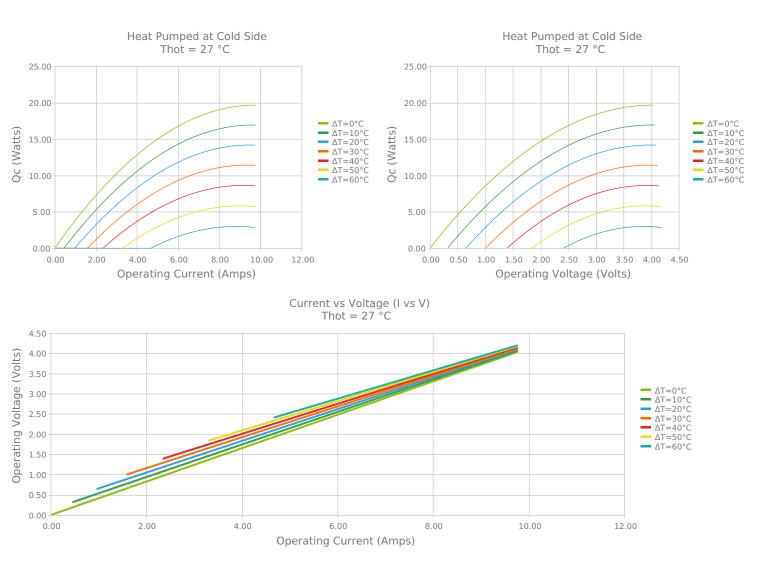
- Compact geometric sizes
- DC Operation
- RoHS-compliant
- **Applications**
- Thermoelectric Coolers for Reagent Storage
- Thermoelectric Coolers for Handheld Cosmetic Lasers
- Cooling for Centrifuges
- Heads-Up Displays, Imaging Sensors
- Peltier Cooling for Machine Vision

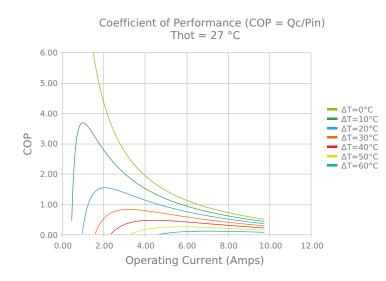


# Solder Construction: 138°C, Bismuth Tin (BiSn)

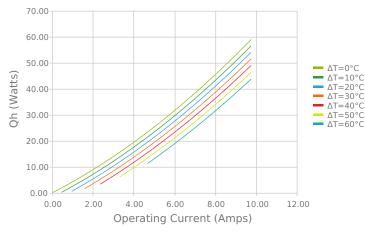
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

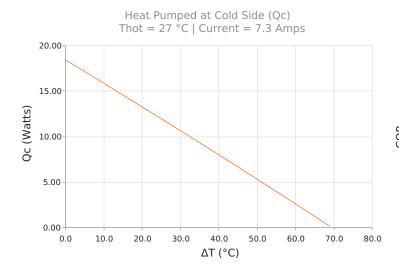
## **ELECTRICAL AND THERMAL PERFORMANCE**

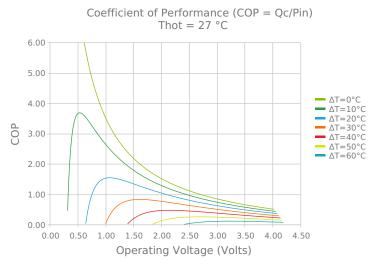


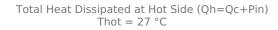


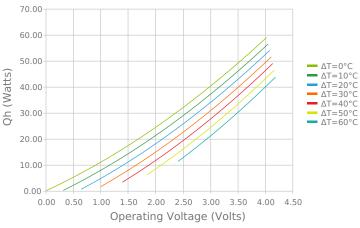




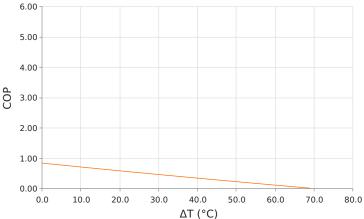








Coefficient of Performance (COP = Qc/Pin) Thot = 27 °C | Current = 7.3 Amps



# **SPECIFICATIONS\***

Hot Side Temperature	27.0 °C	35.0 °C	50.0 °C
$Qcmax (\Delta T = 0)$	19.7 Watts	20.3 Watts	21.3 Watts
$\Delta Tmax (Qc = 0)$	70.5°C	73.5°C	78.8°C
lmax (I @ ΔTmax)	8.6 Amps	8.6 Amps	8.5 Amps
Vmax (V @ ΔTmax)	3.8 Volts	4.0 Volts	4.2 Volts
Module Resistance	0.41 Ohms	0.43 Ohms	0.46 Ohms
Max Operating Temperature	80 °C		
Weight	7.0 gram(s)		

\* Specifications reflect thermoelectric coefficients updated March 2020

# **FINISHING OPTIONS**

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
L1	$3.327 \pm 0.025 \text{ mm}$ $0.131 \pm 0.001 \text{ in}$	0.025 mm / 0.025 mm 0.001 in / 0.001 in	Lapped	Lapped	114.3 mm 4.50 in

## **SEALING OPTIONS**

Suffix	Sealant	Color	Temp Range	Description
RT	RTV	White	-60 to 204°C	Non-corrosive, silicone adhesive

## **NOTES**

- 1. Max operating temperature: 80°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation
- 4. Solder tinning also available on metallized ceramics

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Date: 04/24/2020